

OFFICE OF DEAN OF ACADEMIC AFFAIRS

No. TIET/Merit-C-Means/23-24/

Dated : Dec 21,2023

NOTICE FOR EXTENSION OF DATE FOR APPLYING FOR TIET MERIT- CUM- MEANS SCHOLARSHIP FOR THE YEAR 2023-24

In continuation of our earlier notice dated Nov 27, 2023 regarding **TIET MERIT-CUM-MEANS (MCM) Scholarship** for the year 2023-24. This is for the information of all the concerned that last date of applying for MCM Scholarships is hereby extended further till 12/01/2024 (5.30 pm). **Please note that 12/01/2024 is last extended date and no further date extension will done after this date.** The eligibility criteria and other conditions will be same as per our earlier notice.

Eligible Student can download the application form ((TIET/DOAA/SCH(MCM)/FT-001) available at Thapar Institute website under scholarship link <http://www.thapar.edu/admissions/pages/scholarships>

Submission of MCM application form to the institute:-

- 1) **Soft Copy:** Student has to fill in the Google form in the link <https://forms.gle/iU5Kyo1e6MaNziHo9> or they can scan the given QR code and also have to upload colored scan copies of all supporting documents in the attachment.

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- 2) **Hard Copy:** After submission of soft copy, students have to submit hard copy of application form and other relevant documents also by **12/01/2024 (5.30 pm)** in the Student Scholarship Section, Office of Dean Student Affairs (DOSA), Adjoining Visiting Centre, Learning Centre, Thapar Institute of Engineering & Technology, Patiala , Punjab -147004.

For any further clarification please contact at official number 0175-2393329 / 8288008329
e-mail id: scholarshiptiet@thapar.edu on any working day between 10am to 5pm.

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